

### DDR4 DIMM

TE Internal #: 2309408-1 SO DIMM Sockets, Small Outline (SO), Stack Height .157 in [4 mm], Right Angle Module Orientation, Surface Mount Mount, Cable-to-Board, DDR4 DIMM

### View on TE.com >

Connectors > Socket Connectors > Memory Sockets > SO DIMM Sockets > DDR4 SO DIMM SOCKETS



DRAM Type: Small Outline (SO) Stack Height: 4 mm [.157 in ] Module Orientation: Right Angle PCB Mounting Style: Surface Mount Connector System: Cable-to-Board

### All DDR4 SO DIMM SOCKETS (39)

### Features

### **Product Type Features**

Center Post

### Without



DRAM Type	Small Outline (SO)							
Connector System	Cable-to-Board							
Sealable	No							
Connector & Contact Terminates To	Printed Circuit Board							
Product Type	Socket							
Configuration Features								
Center Key	Offset Right							
Number of Keys	1							
Module Orientation	Right Angle							
Number of Positions	260							
Number of Rows	2							
Keying	Reverse							
Electrical Characteristics								
DRAM Voltage	1.2 V							
Signal Characteristics								

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	1 2 \/
SGRAM Voltage	1.2 V
Body Features	
Ejector Location	Both Ends
Latch Material	High Temperature Thermoplastic
Retention Post Location	Both Ends
Ejector Type	Locking
Connector Profile	Low
Contact Features	
Socket Style	SO DIMM
PCB Contact Termination Area Plating Material	Gold Flash
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold Flash
Contact Current Rating (Max)	.5 A
Socket Type	Memory Card
Termination Features	
Insertion Style	Cam-In
Mechanical Attachment	
PCB Mount Retention	With
PCB Mount Retention Type	Solder Peg
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.5 mm[.02 in]
Housing Color	Black
Housing Material	High Temperature Thermoplastic
Dimensions	
Stack Height	4 mm[.157 in]
Row-to-Row Spacing	8.2 mm[.322 in]
Jsage Conditions	
Operating Temperature Range	-55 – 85 °C[-67 – 185 °F]

**C** For support call+1 800 522 6752

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Circuit Application	Power			
Industry Standards				
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Method	Tape & Reel			
Packaging Quantity	900			
EU RoHS Directive 2011/65/EU	Compliant			
For compliance documentation, visit the product page on TE.com>				
EU ELV Directive 2000/53/EC				
EU EEV DIrective 2000/33/EC	Compliant			
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold			
China RoHS 2 Directive MIIT Order No 32, 2016 EU REACH Regulation (EC) No. 1907/2006				

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

SO DIMM Sockets, Small Outline (SO), Stack Height .157 in [4 mm], Right Angle Module Orientation, Surface Mount Mount, Cable-to-Board, DDR4 DIMM





# Also in the Series DDR4 DIMM



# Customers Also Bought



-= TE			
TE Part #2309407-1 DDR4 SO DIMM SOCKETS	TE Part #5-146276-6 06 MODII HDR SRST B/A .100CL	TE Part #1551920-2 zQSFP+ connector assembly	TE Part #1625812-9 3631B 33UH 15% FIO



## Documents

### Product Drawings DDR4 SODIMM 260P 4.0H RVS

English

### **CAD** Files

3D PDF

3D

SO DIMM Sockets, Small Outline (SO), Stack Height .157 in [4 mm], Right Angle Module Orientation, Surface Mount Mount, Cable-to-Board, DDR4 DIMM



Customer View Model

ENG\_CVM\_CVM\_2309408-1\_1.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_2309408-1\_1.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_2309408-1\_1.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance Product Compliance

English

**Product Compliance** 

English